



## ESD Protection Diode



### Features

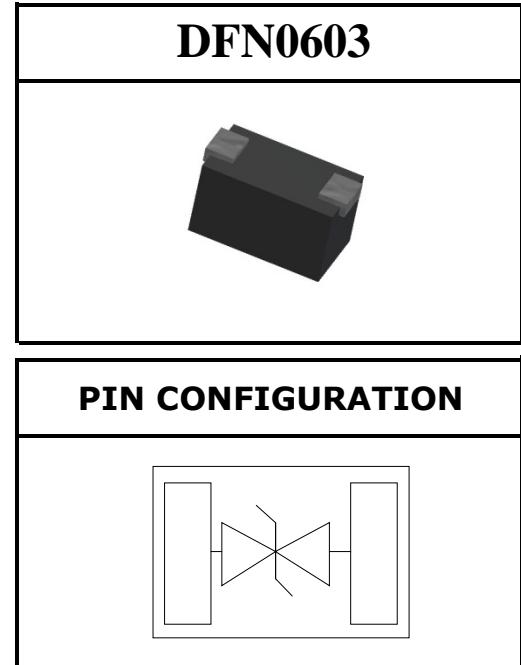
- Capacitance : 5.6pF (typ.)
- Reverse working voltage : 3.3V
- IEC61000-4-2 (ESD) :  $\pm 30\text{kV}$  (air)
- IEC61000-4-2 (ESD) :  $\pm 30\text{kV}$  (contact)
- IEC61000-4-5 (Surge) : 5A (8/20  $\mu\text{s}$ )
- Marking : T

### Main applications

- High Speed Line: USB1.0/2.0, VGA
- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Projection TV
- Cellular handsets and accessories
- Portable instrumentation
- Peripherals

### Ordering Information

Device	Qty per Reel	Reel Size
YT0356AF2	15000	7Inch



### Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Test conditions	Limit	Unit
ESD Rating per IEC61000-4-2	$V_{ESD}$	Contact	$\pm 30$	kV
		Air	$\pm 30$	
Peak pulse power	$P_{PP}$	$tp = 8/20 \mu\text{s}$	60	W
Peak pulse current	$I_{PP}$	$tp = 8/20 \mu\text{s}$	5	A
Operating junction temperature range	$T_J$		-55~+150	°C
Storage temperature range	$T_{STG}$		-55~+150	°C

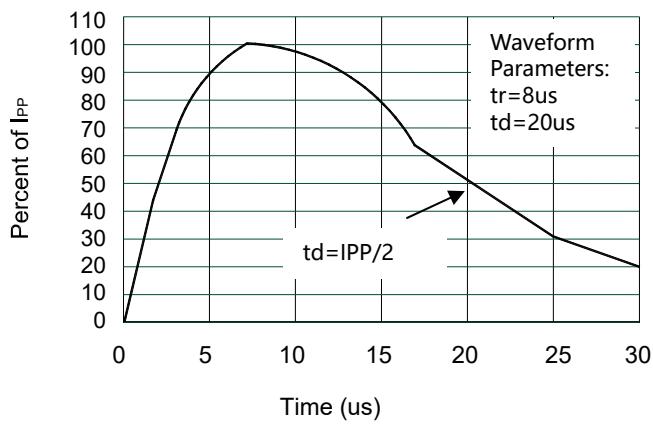
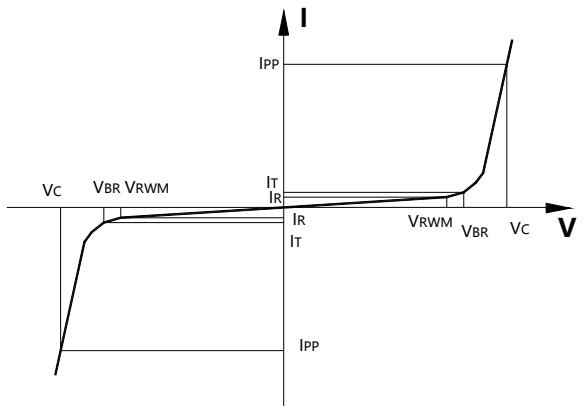
### Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Reverse working voltage	$V_{RWM}$	I/O to GND	-	-	3.3	V
Breakdown voltage	$V_{BR}$	$I_T=1\text{mA}$	3.8	-	-	V
Reverse leakage current	$I_R$	$V_{RWM}=3.3\text{V}$	-	0.1	1.0	uA
Clamping voltage (8/20us)	$V_C$	$I_{PP}=1\text{A}$	-	-	7.6	V
Junction capacitance	$C_J$	$V_R=0\text{V}, f=1\text{MHz}$	-	5.6	10	pF

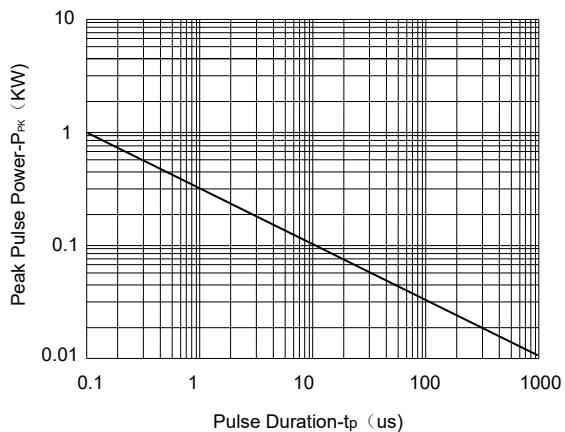
# DEVICE CHARACTERISTICS

## YT0356AF2

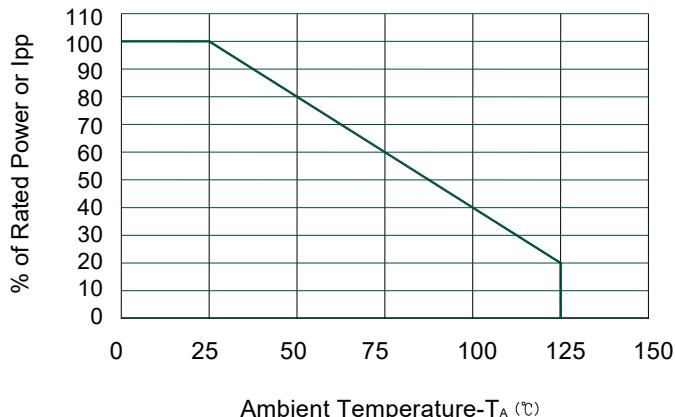
Symbol	Parameter
$V_{RWM}$	Working Peak Reverse Voltage
$V_{BR}$	Breakdown Voltage @ $I_T$
$V_C$	Clamping Voltage @ $I_{PP}$
$I_T$	Test Current
$I_{RM}$	Leakage current at $V_{RWM}$
$I_{PP}$	Peak pulse current
$C_O$	Off-state Capacitance
$C_J$	Junction Capacitance



Pulse Waveform



Non-Repetitive Peak Pulse Power vs. Pulse Time



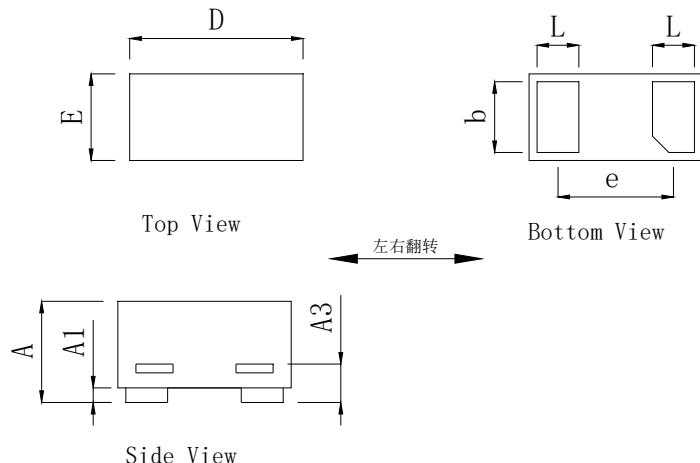
# PACKAGE OUTLINE & DIMENSIONS

## YT0356AF2

### Mechanical Data

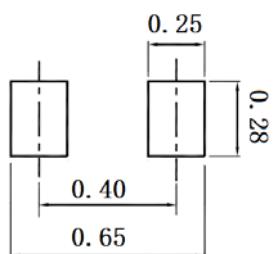
Case: DFN0603

Case Material: Molded Plastic. UL Flammability

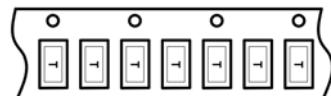


DIM	Millimeters	
	Min	Max
A	0.230	0.330
A1	0.000	0.050
A3	0.102REF	
D	0.550	0.650
E	0.250	0.350
b	0.215	0.275
L	0.115	0.175
e	0.40BSC	

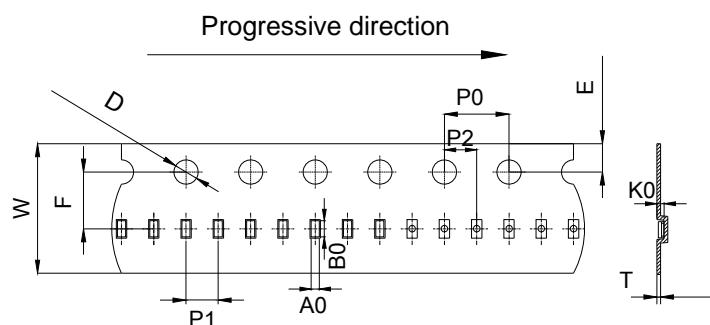
### Recommended Pad outline



### Device Orientation in Tape



### Device Orientation in Tape



PACKAGE	W	E	F	P0	D	P2	P1	T	A0	B0	K0
DFN0603	8mm ±0.1	1.75mm ±0.1	3.5mm ±0.05	4mm ±0.1	1.5mm ±0.1	2mm ±0.05	2mm ±0.1	0.23mm ±0.02	0.34mm ±0.05	0.67mm ±0.05	0.4mm ±0.05